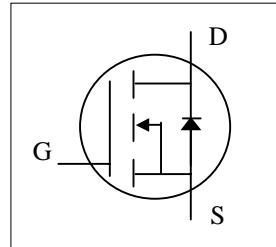
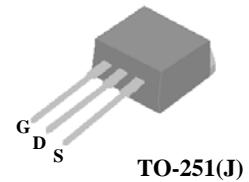




- ▼ 100% R_g & UIS Test
- ▼ Fast Switching Characteristic
- ▼ Simple Drive Requirement
- ▼ RoHS Compliant & Halogen-Free



V _{DS} @ T _{j,max.}	750V
R _{DS(ON)}	0.38Ω
I _D ³	11A



Description

AP70SL380A series are from Advanced Power innovative design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The straight lead version TO-251 package is widely preferred for all commercial-industrial through hole applications.

Absolute Maximum Ratings@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	700	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Drain Current, V _{GS} @ 10V ³	11	A
I _D @T _C =100°C	Drain Current, V _{GS} @ 10V ³	6.5	A
I _{DM}	Pulsed Drain Current ¹	24	A
dv/dt	MOSFET dv/dt Ruggedness (V _{DS} = 0 ... 400V)	50	V/ns
P _D @T _C =25°C	Total Power Dissipation	78.1	W
P _D @T _A =25°C	Total Power Dissipation	1.13	W
E _{AS}	Single Pulse Avalanche Energy ⁴	75	mJ
dv/dt	Peak Diode Recovery dv/dt ⁵	15	V/ns
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Units
R _{thj-c}	Maximum Thermal Resistance, Junction-case	1.6	°C/W
R _{thj-a}	Maximum Thermal Resistance, Junction-ambient	110	°C/W



Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	700	-	-	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance ²	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=3.2\text{A}$	-	-	0.38	Ω
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2	-	5	V
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}, I_{\text{D}}=3.2\text{A}$	-	7.8	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=480\text{V}, V_{\text{GS}}=0\text{V}$	-	-	100	μA
I_{GSS}	Gate-Source Leakage	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
Q_g	Total Gate Charge	$I_{\text{D}}=3.2\text{A}$	-	33	52.8	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=560\text{V}$	-	8	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{\text{GS}}=10\text{V}$	-	13	-	nC
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=350\text{V}$	-	13	-	ns
t_r	Rise Time	$I_{\text{D}}=3.2\text{A}$	-	8	-	ns
$t_{\text{d(off)}}$	Turn-off Delay Time	$R_{\text{G}}=3.3\Omega$	-	37	-	ns
t_f	Fall Time	$V_{\text{GS}}=10\text{V}$	-	12	-	ns
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$	-	1240	1984	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=100\text{V}$	-	35	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	5	-	pF
R_g	Gate Resistance	f=1.0MHz	-	3.5	7	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_{\text{S}}=3.2\text{A}, V_{\text{GS}}=0\text{V}$	-	0.8	-	V
t_{rr}	Reverse Recovery Time	$I_{\text{S}}=11\text{A}, V_{\text{GS}}=0\text{V}$	-	320	-	ns
Q_{rr}	Reverse Recovery Charge	dl/dt=50A/ μs	-	2.5	-	μC

Notes:

- 1.Pulse width limited by max. junction temperature.
- 2.Pulse test
- 3.Limited by max. junction temperature. Maximum duty cycle D=0.75
- 4.Starting $T_j=25^\circ\text{C}$, $V_{\text{DD}}=50\text{V}$, $L=150\text{mH}$, $R_{\text{G}}=25\Omega$
5. $I_{\text{SD}} \leq I_{\text{D}}$, $V_{\text{DD}} \leq \text{BV}_{\text{DSS}}$, starting $T_j = 25^\circ\text{C}$

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

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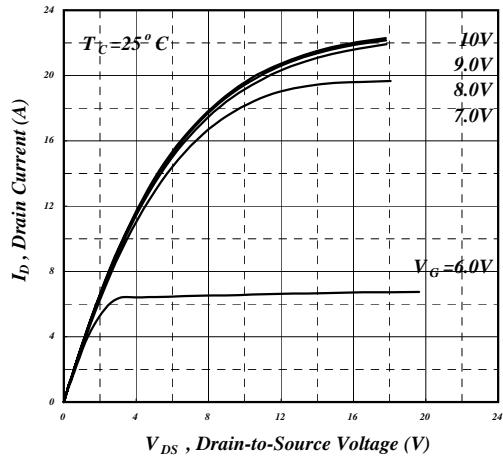


Fig 1. Typical Output Characteristics

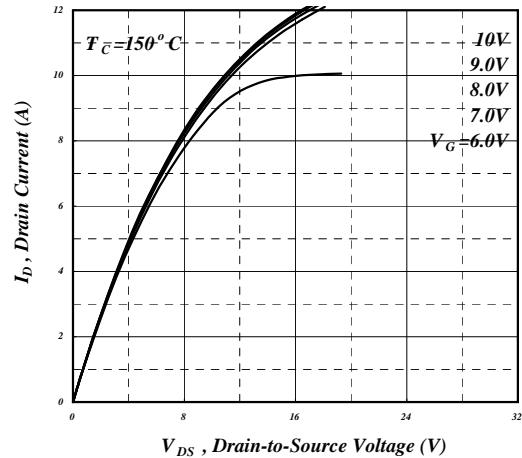


Fig 2. Typical Output Characteristics

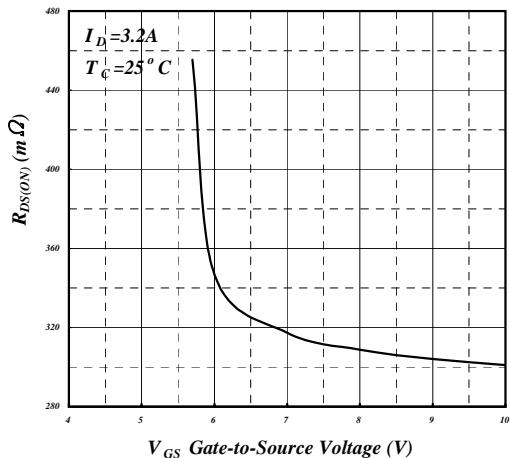


Fig 3. On-Resistance v.s. Gate Voltage

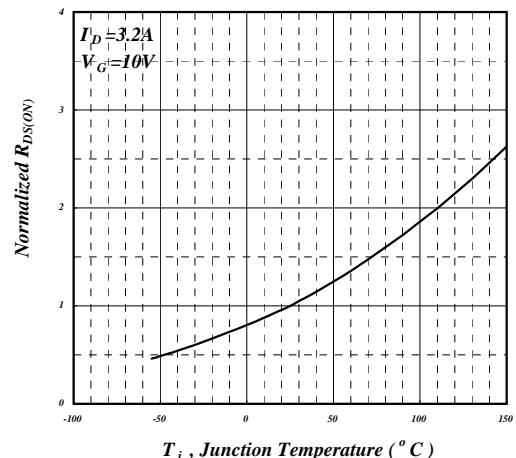


Fig 4. Normalized On-Resistance v.s. Junction Temperature

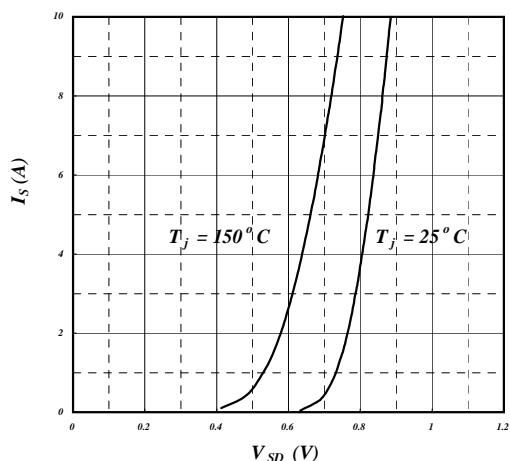


Fig 5. Forward Characteristic of Reverse Diode

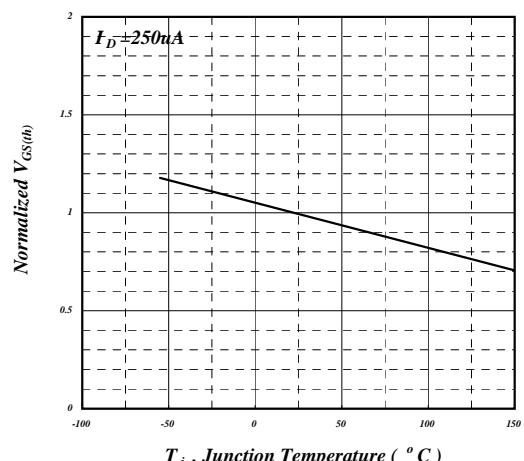


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

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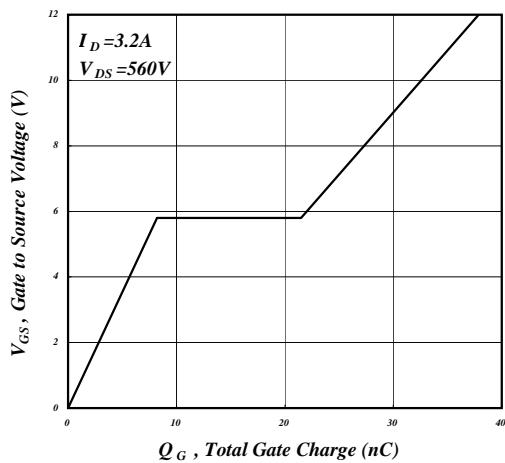


Fig 7. Gate Charge Characteristics

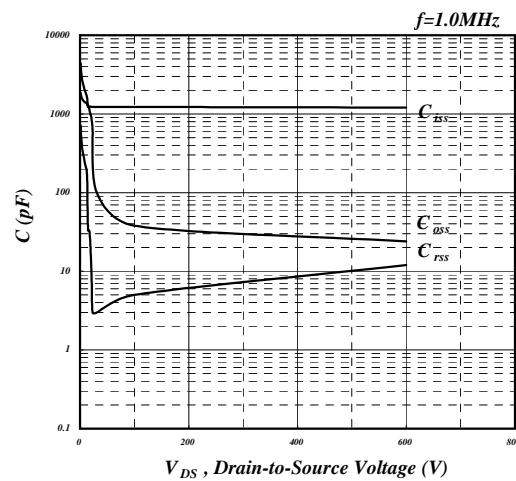


Fig 8. Typical Capacitance Characteristics

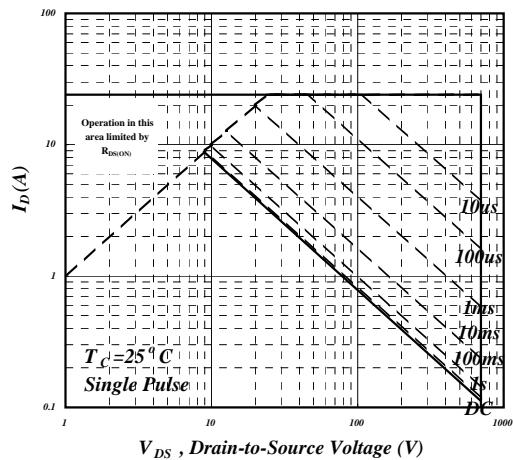


Fig 9. Maximum Safe Operating Area

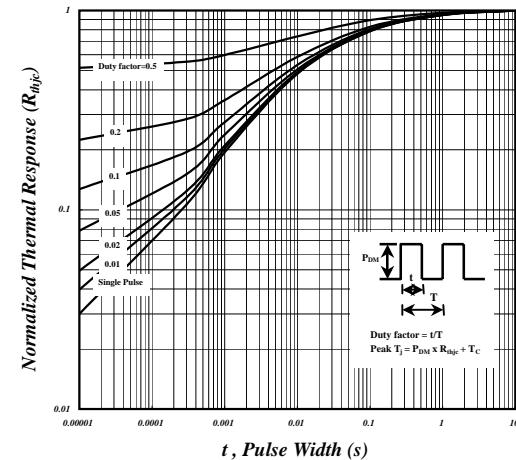


Fig 10. Effective Transient Thermal Impedance

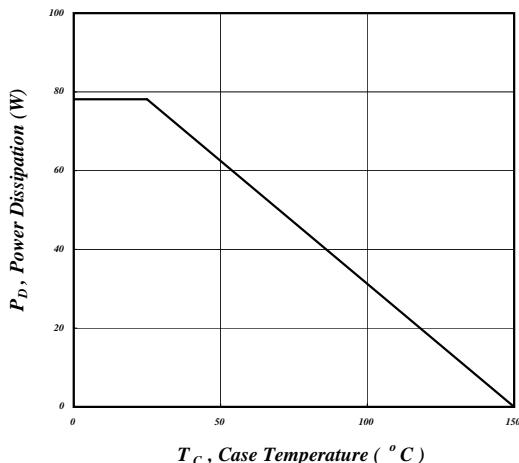


Fig 11. Total Power Dissipation

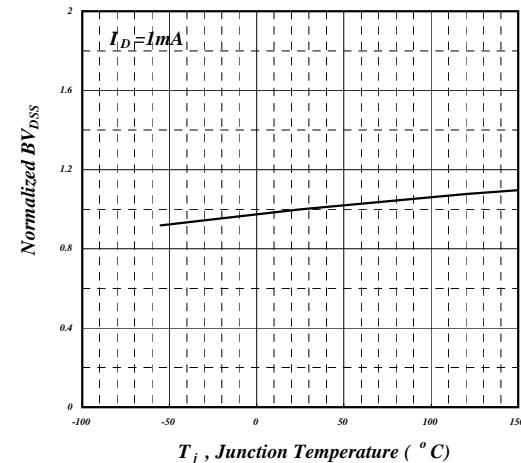


Fig 12. Normalized BV_{DSS} v.s. Junction Temperature



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MARKING INFORMATION

